

**AMENDMENTS TO THE SPECIFICATION**

Please amend page 1, paragraph [0001] as follows:

This application is a U.S. National Phase application of PCT/US2004/014209, filed May 7, 2004, which claims the benefit of United States Provisional Application No. 60/468,801, filed 7 May 2003 and entitled "LAMINATED THERMAL MANAGEMENT COIN/SLUG FOR PRINTED CIRCUIT BOARDS," the ~~entirety~~entireties of which ~~is~~are incorporated herein by reference.